Liu Lu

List of Publications by Year in descending order

Source: https://exaly.com/author-pdf/8057162/publications.pdf

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	2258059		2053705	
5	30	3	5	
papers	citations	h-index	g-index	
5	5	5	16	
all docs	docs citations	times ranked	citing authors	

#	Article	IF	Citations
1	Three-dimensional interface and property of SnPb solder joint under extreme thermal shocking. Science and Technology of Welding and Joining, 2022, 27, 186-196.	3.1	12
2	Influence of 0.05 wt% Pr addition on interfacial microstructure and mechanical properties of Sn–0.3Ag–0.7Cu/Cu solder joint during thermal shocking. Journal of Materials Science: Materials in Electronics, 2022, 33, 7099-7108.	2.2	2
3	Board Level Drop Test for Evaluating the Reliability of High-Strength Sn–Bi Composite Solder Pastes with Thermosetting Epoxy. Crystals, 2022, 12, 924.	2.2	2
4	Study on the Reliability of Sn–Bi Composite Solder Pastes with Thermosetting Epoxy under Thermal Cycling and Humidity Treatment. Crystals, 2021, 11, 733.	2.2	6
5	Mechanical Property of Sn-58Bi Solder Paste Strengthened by Resin. Applied Sciences (Switzerland), 2018, 8, 2024.	2.5	8